GP1S96

Features

- 1. Compact package (3.5×2.6×3.1mm)
- 2. Low profile (Height : 3.1mm)
- 3. Gap width : 1.0mm
- 4. Slit width (detector side) : 0.3mm

Applications

- 1. Cameras
- 2. DVD players
- 3. CD-ROM drivers
- 4. Floppy disk drivers

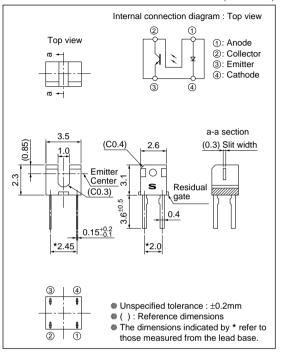
■ Absolute Maximum Ratings (Ta=25°C)								
	Parameter	Symbol	Rating	Unit				
Input	Forward current	IF	50	mA				
	Reverse voltage	VR	6	V				
	Power dissipation	Р	75	mW				
	Collector-emitter voltage	or-emitter voltage VCEO 35		V				
Output	Emitter-collector voltage	VECO	6	V				
	Collector current	Ic	20	mA				
	Collector power dissipation	Pc	75	mW				
	Total power dissipation		100	mW				
	Operating temperature		-25 to +85	°C				
	Storage temperature	Tstg	-40 to +100	°C				
*	*1 Soldering temperature		260	°C				

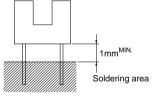
*1 For 5s or less

Subminiature, Transmissive Type Photointerrupter

Outline Dimensions

(Unit : mm)





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Electro-optical Characteristics									
Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		VF	IF=20mA	-	1.2	1.4	V	
	Reverse current		Ir	V _R =3V	-	-	10	μA	
Output	Collector dark current		Iceo	Vce=20V	-	-	100	nA	
Transfer charac- teristics	Collector current		Ic	Vce=5V, IF=5mA	100	-	400	μA	
	Response time	Rise time	tr	Vce=5V, Ic=100µA	-	50	150	μs	
		Fall time	tr	$R_L=1\ 000\Omega$	-	50	150	μs	
	Collector-emitter saturation voltage		VCE(sat)	IF=10mA, Ic=50µA	-	-	0.4	V	

Fig.1 Forward Current vs. Ambient Temperature

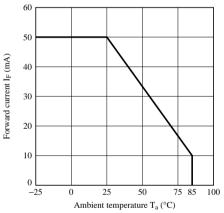


Fig.3 Forward Current vs. Forward Voltage

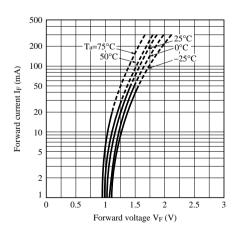


Fig.2 Power Dissipation vs. Ambient Temperature

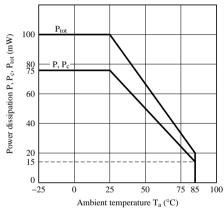


Fig.4 Collector Current vs. Forward Current

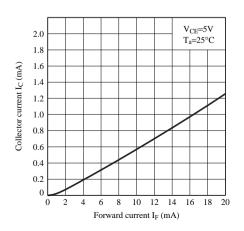


Fig.5 Collector Current vs. Collector-emitter Voltage

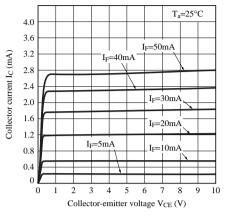


Fig.7 Collector - emitter Saturation Voltage vs. Ambient Temperature

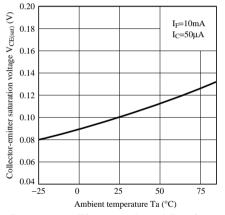


Fig.9 Response Time vs. Load Resistance

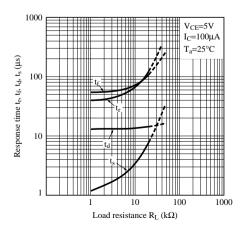


Fig.6 Relative Collector Current vs. Ambient Temperature

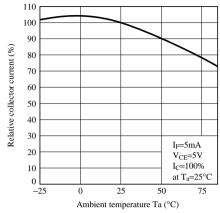


Fig.8 Collector Dark Current vs. Ambient Temperature

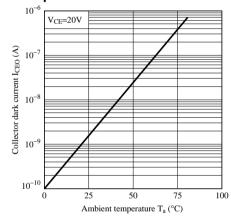


Fig.10 Test Circuit for Response Time

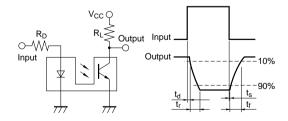


Fig.11 Relative Collector Current vs. Shield Distance (1) (Typical Value)

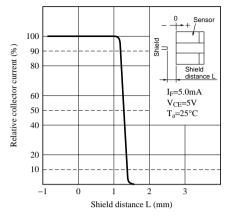
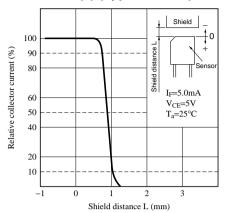


Fig.12 Relative Collector Current vs. Shield Distance (2) (Typical Value)



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 - Test and measurement equipment
 - Industrial control
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- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

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